

# PRODUCT SPECIFICATION

**Model No.: CSDM-57200X CSDM-57201X**

Descriptions:
<ul style="list-style-type: none"> <li>■ 2.0 Inch Dot-Matrix Display</li> <li>■ 5*7 Array with X-Y Select</li> <li>■ CSDM-57200 is Common Column Cathode</li> <li>■ CSDM-57201 is Common Column Anode</li> <li>■ Emitting Color: Pure Green; Yellow Green; Yellow; Amber; Orange; Red; Deep Red</li> <li>■ Standard: -11: Gray face, white Dot. -21: Black face, white Dot.</li> </ul>



CUSTOMER APPROVED SIGNATURES	APPROVED BY	CHECKED BY	PREPARED BY

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**Model No.: CSDM-57200X CSDM-57201X**

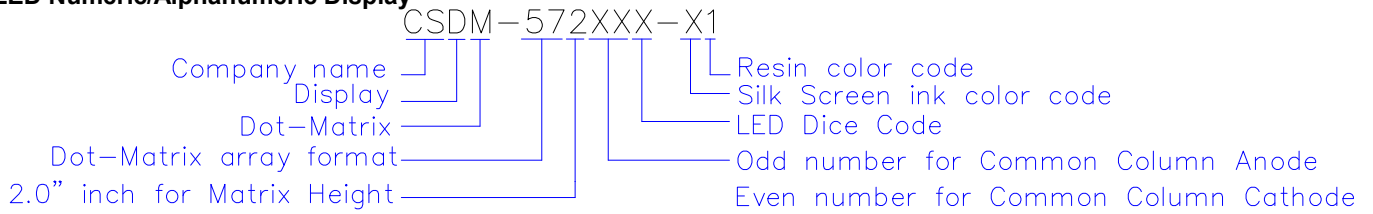
**■ Features -**

1. 2.0 inch (50.72mm) Matrix height.
2. Case mold type.
3. RoHS compliant.
4. Low power consumption.
5. Easy mounting on P.C. board or socket.

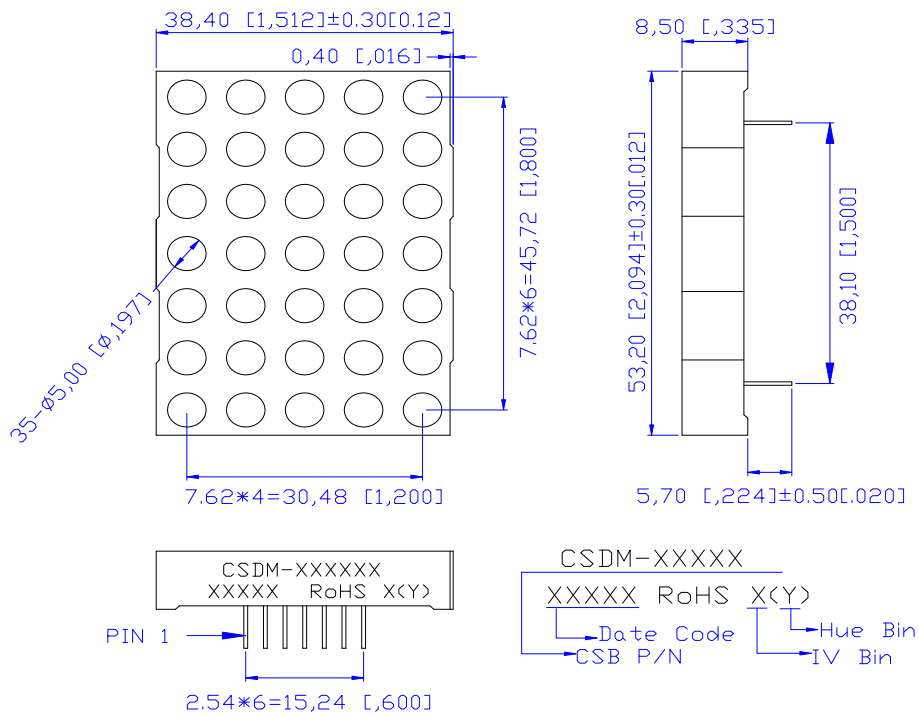
**■ Device Selection Guide -**

Model No.	Chip	
	Material	Emitting Color
CSDM-5720x2	AlGaN	Pure Green
CSDM-5720xM		Yellow Green
CSDM-5720xT		Yellow
CSDM-5720xA		Amber
CSDM-5720xV		Orange
CSDM-5720xL		Red
CSDM-5720xU		Deep Red

**■ LED Numeric/Alphanumeric Display**



**■ Mechanical Dimensions -**

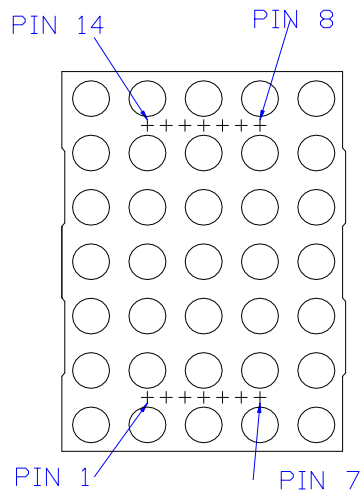


**Notes:**

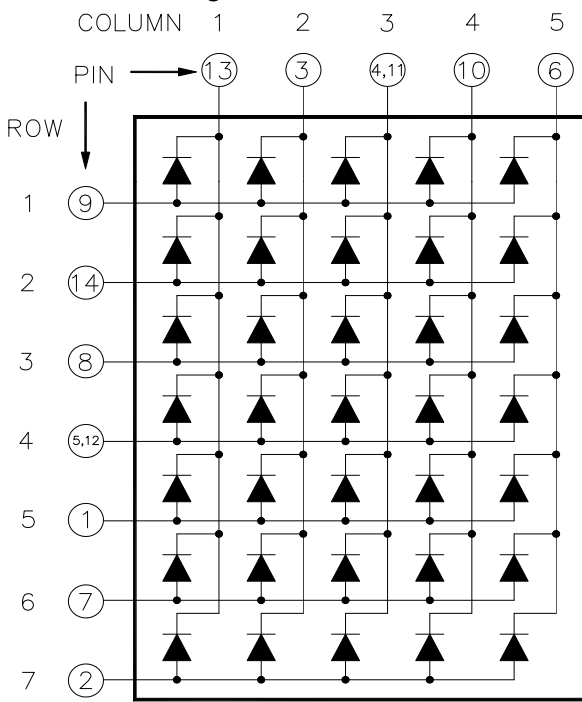
1. All pins are  $\Phi 0.51[.020] \pm 0.1[.004]$
2. Dimension in millimeter [inch], tolerance is  $\pm 0.25 [0.010]$  and angle is  $\pm 1^\circ$  unless otherwise noted.
3. Bending  $\leq$  Length\*1%.

Model No.: CSDM-57200X CSDM-57201X

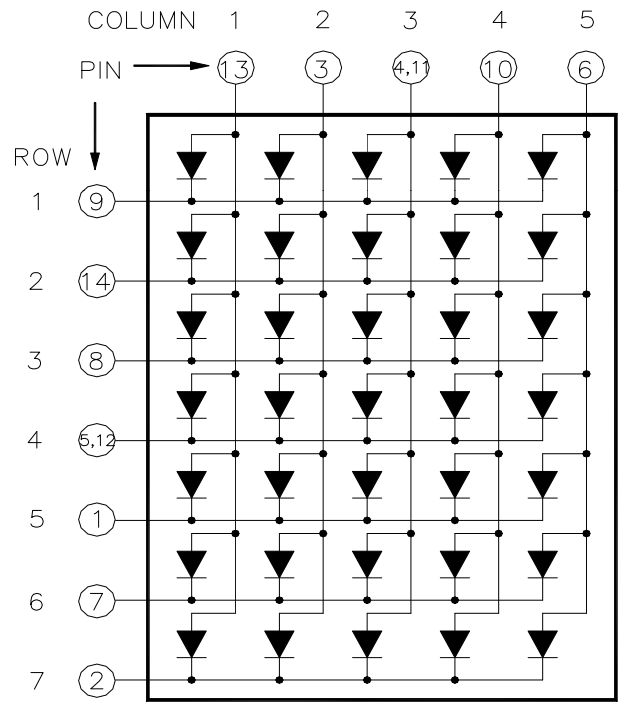
■ All Light On Segments Feature & Pin Position



■ Internal Circuit Diagrams -



CSDM-57200 is Common Column Cathode



CSDM-57201 is Common Column Anode

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■ Absolute Maximum Rating -

(Ta=25°C)

Parameter	Symbol	Rating		Unit
		M/T/A/V/L/U	2	
Power Dissipation Per Dice	PAD	70	114	mW
Derating Liner from 25°C per Dice	-	0.33	0.4	mA/°C
Continuous Forward Current Per Dice	IAF	25	30	mA
Peak Current Per Dice(duty cycle 1/10,1KHz)	IPF	90	100	mA
Reverse Voltage Per Dice	VR	5	5	V
Electrostatic discharge(HBM)	ESD	/	1000	V
Operating Temp.	Topr	-35 ~ +85		°C
Storage Temp.	Tstg	-35 ~ +85		°C
Hand Soldering Temp.	Tsol	350		°C

■ Electro-optical Characteristics -

(Ta=25°C)

Parameter	Symbol	Chip	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity Per Segment	Iv	2	-	430	-	mcd	If=10mA
		M	-	28	-		
		T	-	100	-		
		A	-	100	-		
		V	-	80	-		
		L	-	80	-		
		U	-	20	-		
Forward Voltage Per Segment	VF	2	-	3.2	3.8	V	If=20mA
		M/T/A/V/L/U	-	2	2.8		
Peak Emission Wavelength / Dominant Wavelength	λP/λd	2	-	*525	-	nm	If=20mA
		M	-	572/570	-		
		T	-	592/590	-		
		A	-	612/605	-		
		V	-	632/625	-		
		L	-	644/630	-		
		U	-	660/645	-		
Reverse Current	IR		-	-	100	μA	VR=5V
Luminous Intensity Matching Ratio	IV-m		-	-	2:1	-	*1

Notes: \*1 Condition is Ip=80mA 1/16Duty

■ Electrical / Optical Characteristics Curves -

(Ta = 25°C Unless Otherwise Noted)

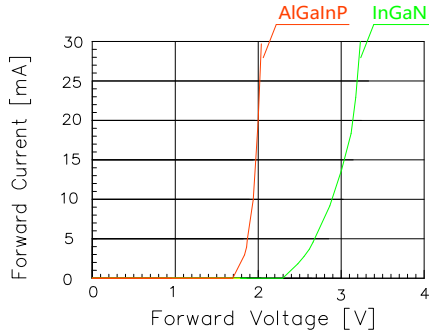


Fig 1. Forward Current vs. Forward Voltage

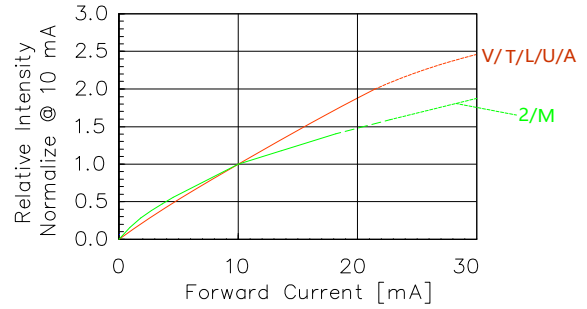


Fig 2. Relative Intensity vs. Forward Current

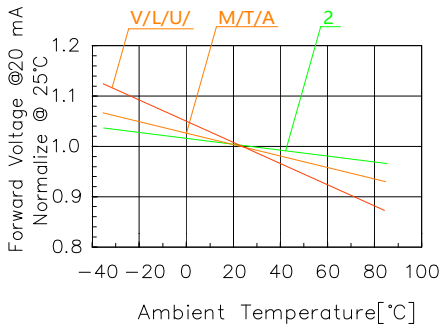


Fig 3. Forward Voltage vs. Temperature

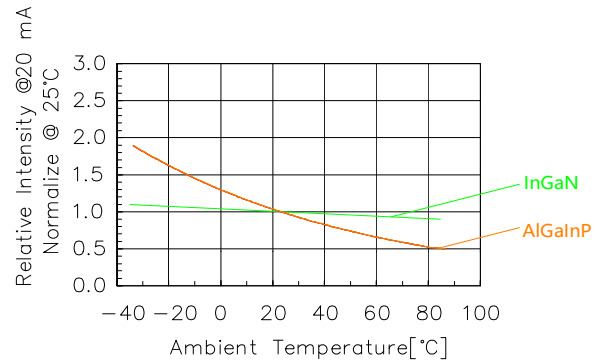


Fig 4. Relative Intensity vs. Temperature

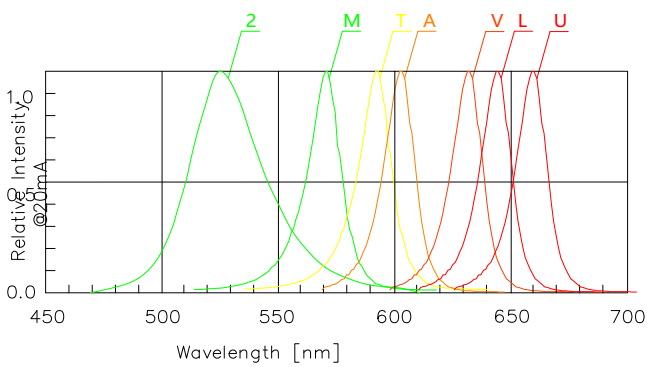


Fig 5. Relative Intensity vs. Wavelength

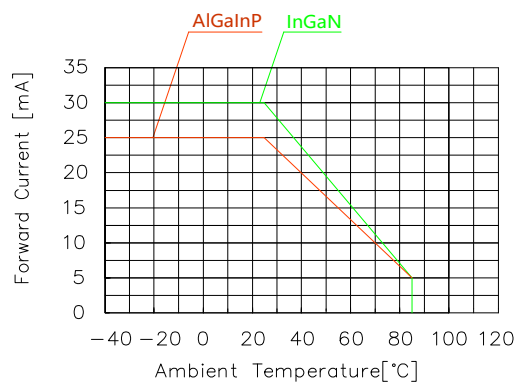


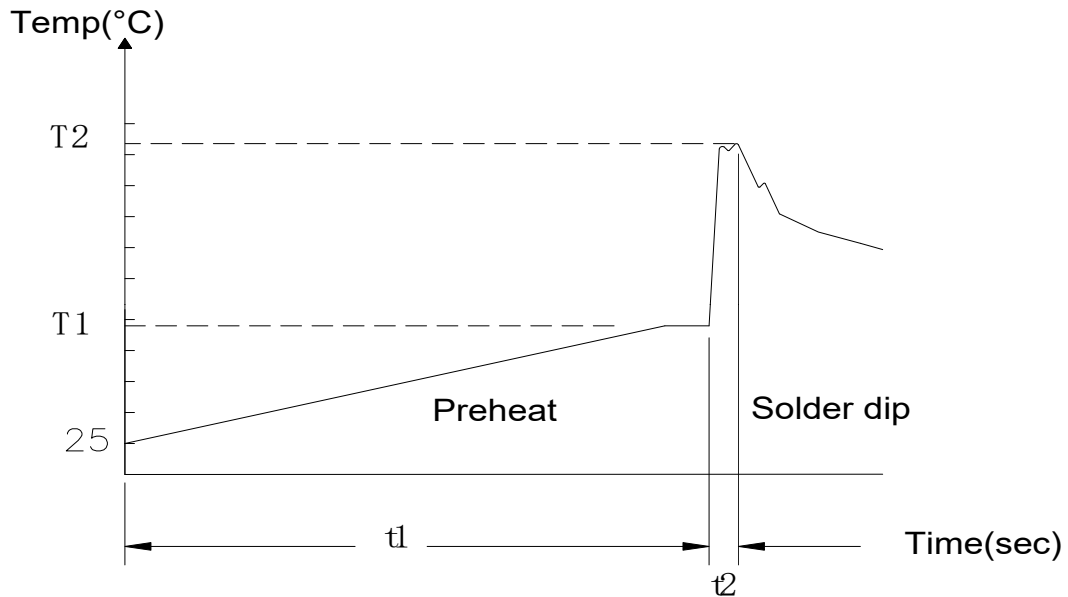
Fig 6. Forward current vs. Temperature

■ Precautions For Use -

1.Wave Soldering Profile

Distance:1.6mm min(From seating plane)

Item	Condition		Note
Preheat	Temperature T1	80 - 120°C	PWB temperature (Soldering side surface)
	Time t1	60 - 180sec	
Solder Dip	Temperature T2	230 - 260°C	Bath temperature
	Time t2	2 - 4sec	Solder tank passage time



2.Hand Soldering (Iron Condition)

Soldering Iron:30W Max

Temperature 350°C Max

Soldering Time:3 Seconds Max(One Time)

Distance:1.6mm min(From seating plane)